RENESAS 25MHz 3.2 x 2.5mm Reference Crystal

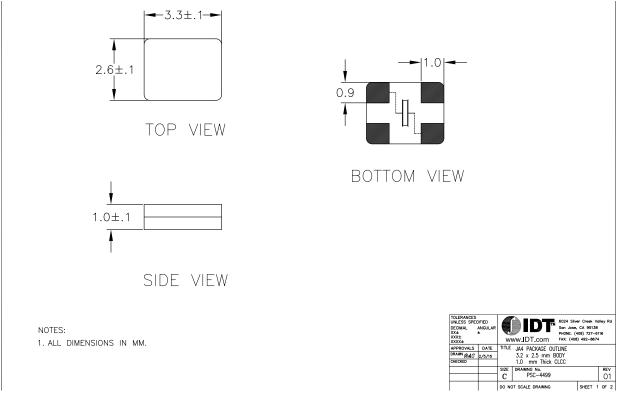
603-25-150

DATASHEET

Specifications

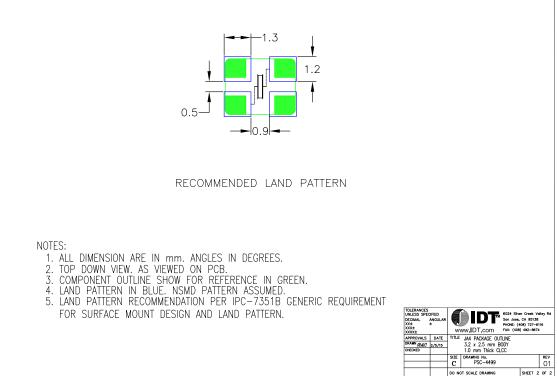
Parameters	Ratings/Units	
Frequency	25.000 MHz	
Resonance Mode	Fundamental	
Frequency Tolerance @ 25°C	±20 PPM Max	
Frequency Stability, ref @ 25°C Over Operating Temperature Range	±20 PPM Max	
Temperature Range Operating (TOPR)	0°C ~ +70°C -40°C ~ +85°C	
Temperature Range, Storage (Tstg)	-40°C ~ +85°C	
Equivalent Series Resistance (ESR)	50 Ohms Max	
Shunt Capacitance (Co)	7 pF Max	
Load Capacitance (CL)	8 pF	
Drive Level	0.3 mW Max	
Aging per year	±5 PPM Max	
Maximum Soldering Temp / Time	260°C / 10 Seconds	
Moisture Sensitivity Level (MSL)	1	
Termination Finish	Au	
Weight (TYP)	16.75 mg	
RoHS Compliant, Pb-free		

Package Outline and Dimensions (JA4)



RENESAS





Ordering Information

Part / Order Number	Shipping Packaging	Package	Temperature
603-25-150JA4C	Cut-Tape	3.2 x 2.5 x 1.0 mm JA4 CLCC	0 to +70 °C
603-25-150JA4C8	Tape and Reel	3.2 x 2.5 x 1.0 mm JA4 CLCC	0 to +70 °C
603-25-150JA4I	Cut-Tape	3.2 x 2.5 x 1.0 mm JA4 CLCC	-40 to +85 °C
603-25-150JA4I8	Tape and Reel	3.2 x 2.5 x 1.0 mm JA4 CLCC	-40 to +85 °C

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